

10-A NON-ISOLATED DDR/QDR **POLA**TM MEMORY BUS TERMINATION MODULES

FEATURES

- V_{TT} Bus Termination Output (Output Tracks the System V_{REF})
- 10 A Output Current
- 3.3-V, 5-V or 12-V Input Voltage
- DDR and QDR Compatible
- On/Off Inhibit (for V_{TT} Standby)
- Undervoltage Lockout
- Operating Temperature: -40°C to 85°C
- Efficiencies up to 91%
- Output Overcurrent Protection (Non-Latching, Auto-Reset)
- 57 W/in³ Power Density
- Safety Agency Approvals: UL/cUL60950, EN60950, VDE
- Point-of-Load Alliance (POLATM) Compatible



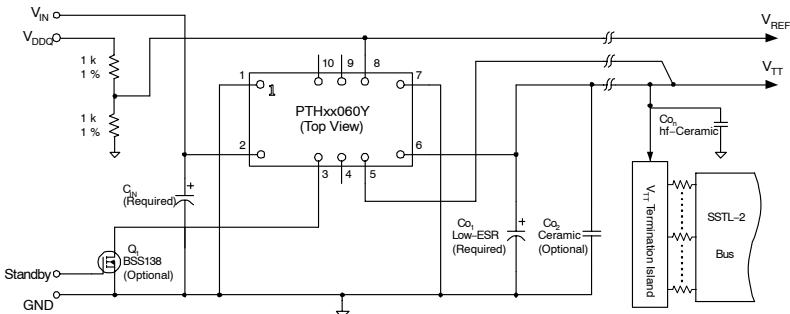
DESCRIPTION

The PTHxx060Y are a series of ready-to-use switching regulator modules from Texas Instruments designed specifically for bus termination in DDR and QDR memory applications. Operating from either a 3.3-V, 5-V or 12-V input, the modules generate a V_{TT} output that will source or sink up to 10 A of current to accurately track their V_{REF} input. V_{TT} is the required bus termination supply voltage, and V_{REF} is the reference voltage for the memory and chipset bus receiver comparators. V_{REF} is usually set to half the V_{DDQ} power supply voltage.

Both the PTHxx060Y series employs an actively switched synchronous rectifier output to provide state-of-the-art stepdown switching conversion. The products are small in size (1 in \times 0.62 in), and are an ideal choice where space, performance, and high efficiency are desired, along with the convenience of a ready-to-use module.

Operating features include an on/off inhibit and output over-current protection (source mode only). The on/off inhibit feature allows the V_{TT} bus to be turned off to save power in a standby mode of operation. To ensure tight load regulation, an output remote sense is also provided. Package options include both throughhole and surface mount configurations.

STANDARD APPLICATION



C_N = Required Capacitor; 330 μF (3.3 \pm 5 V Input), 560 μF (12 V Input).

C_1 = Required Low-ESR Electrolytic Capacitor; 470 μF (3.3 \pm 5 V Input), 940 μF (12 V Input).

C_2 = Ceramic Capacitance for Optimum Response to a 3 A (+ 1.5 A) Load Transient; 200 μF (3.3 \pm 5 V Input), 400 μF (12 V Input).

C_{hf} = Distributed hf-Ceramic Decoupling Capacitors for V_{TT} bus; as Recommended for DDR Memory Applications.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

POLA is a trademark of Texas Instruments.

ORDERING INFORMATION

| PTHXX060Y (Base Part Number) | | | | |
|------------------------------|----------------------------|----------------|--------------------|-----------------------------------|
| Input Voltage | Part Number ⁽¹⁾ | DESCRIPTION | Pb – free and RoHS | Mechanical Package ⁽²⁾ |
| 3.3 V | PTH03060YAH | Horizontal T/H | Yes ⁽³⁾ | EUW |
| | PTH03060YAS | Standard SMD | No ⁽⁴⁾ | EUY |
| | PTH03060YAZ | Optional SMD | Yes ⁽³⁾ | EUY |
| 5 V | PTH05060YAH | Horizontal T/H | Yes ⁽³⁾ | EUW |
| | PTH05060YAS | Standard SMD | No ⁽⁴⁾ | EUY |
| | PTH05060YAZ | Optional SMD | Yes ⁽³⁾ | EUY |
| 12 V | PTH12060YAH | Horizontal T/H | Yes ⁽³⁾ | EUW |
| | PTH12060YAS | Standard SMD | No ⁽⁴⁾ | EUY |
| | PTH12060YAZ | Optional SMD | Yes ⁽³⁾ | EUY |

(1) Add T to end of part number for tape and reel on SMD packages only.
 (2) Reference the applicable package reference drawing for the dimensions and PC board layout.
 (3) *Lead (Pb) –free* option specifies Sn/Ag pin solder material.
 (4) *Standard* option specifies 63/37, Sn/Pb pin solder material.

ENVIRONMENTAL AND ABSOLUTE MAXIMUM RATINGS

voltages are with respect to GND

| | | | | UNIT |
|--------------|-----------------------------|--|-------------|------------------------------|
| V_{REF} | Control input voltage | | | –0.3 V to $V_{IN}+03$ V |
| T_A | Operating temperature range | Over V_{IN} range | | –40°C to 85°C ⁽¹⁾ |
| T_{wave} | Wave solder temperature | Surface temperature of module body or pins (5 seconds) | PTHXX060YAH | 260°C ⁽²⁾ |
| T_{reflow} | Solder reflow temperature | Surface temperature of module body or pins | PTHXX060YAS | 235°C ⁽²⁾ |
| | | | PTHXX060YAZ | 260°C ⁽²⁾ |
| T_s | Storage temperature | | | –40°C to 125°C |
| | Mechanical shock | Per Mil-STD-883D, Method 2002.3 1 msec, 1/2 Sine, mounted | | 500 G |
| | Mechanical vibration | Mil-STD-883D, Method 2007.2 20-2000 Hz | | 20 G |
| | Weight | | | 3.7 grams |
| | Flammability | Meets UL 94V-O | | |

(1) For operation below 0°C, the external capacitors must have stable characteristics, use either a low ESR tantalum, Os-Con, or ceramic capacitor.
 (2) During soldering of package version, do not elevate peak temperature of the module, pins or internal components above the stated maximum.

ELECTRICAL SPECIFICATIONS

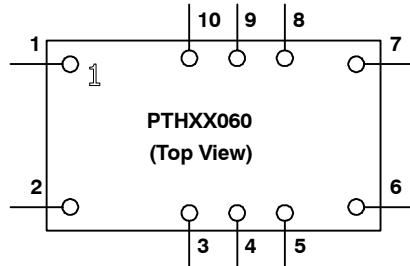
$T_A = 25^\circ\text{C}$; nominal V_{IN} ; $V_{REF} = 1.25 \text{ V}$; C_{IN} , C_O1 , and C_O2 = typical values; and $I_O = I_{O\max}$ (unless otherwise stated)

| PARAMETER | | TEST CONDITIONS | | MIN | TYP | MAX | UNIT |
|---|---|---|-----------------------|--------------------|---------------------|-----|------------------|
| I_O | Output current | Over ΔV_{REF} range | Continuous | 0 | $\pm 10^{(1)}$ | A | |
| V_{IN} | Input voltage range | Over I_O range | PTH03060Y | 2.95 | 3.65 | | V |
| | | | PTH05060Y | 4.5 | 5.5 | | |
| | | | PTH12060Y | 10.8 | 13.2 | | |
| ΔV_{REF} | Tracking range for V_{REF} | | | 0.55 | 1.8 | | V |
| $ V_{TT} - V_{REF} $ | Tracking tolerance to V_{REF} | Over line, load and temperature | | -10 | 10 | | mV |
| η | Efficiency | $I_O = 8 \text{ A}$ | PTH03060Y | 86% | | | |
| | | | PTH05060Y | 86% | | | |
| | | | PTH12060Y | 83% | | | |
| V_r | V_o Ripple (pk-pk) | 20 MHz bandwidth | | 20 | | | mVpp |
| $I_{O\text{ trip}}$ | Overshoot threshold | Reset, followed by auto recovery | | 20 | | | A |
| t_{tr} | Load transient response | 15 A/ μs load step, from: -1.5 A to 1.5 A | Recovery time | 30 | | | μsec |
| V_{tr} | | | V_o over/undershoot | 25 | 40 | | mV |
| UVLO | Under-voltage lockout | V_{IN} Increasing | PTH03060Y | 2.45 | 2.8 | | V |
| | | | PTH05060Y | 4.3 | 4.45 | | |
| | | | PTH12060Y | 9.5 | 10.4 | | |
| | | V_{IN} Decreasing | PTH03060Y | 2.0 | 2.40 | | V |
| | | | PTH05060Y | 3.4 | 3.7 | | |
| | | | PTH12060Y | 8.8 | 9 | | |
| V_{IH} | Inhibit control (pin 4) Input high voltage | Referenced to GND | | $V_{IN} - 0.5$ | Open ⁽²⁾ | | V |
| V_{IL} | Inhibit control (pin 4) Input low voltage | | | -0.2 | 0.6 | | V |
| $I_{IL\text{ inhibit}}$ | Inhibit control (pin 4) Input low current | Pin to GND | | 130 | | | μA |
| $I_{IN\text{ inh}}$ | Input standby current | Inhibit control (pin 4) to GND | | 10 | | | mA |
| f_s | Switching frequency | Over V_{IN} and I_O ranges | PTH03060Y/PTH05060Y | 250 | 300 | 350 | kHz |
| | | | PTH12060Y | 200 | 250 | 300 | |
| C_{IN} | External input capacitance | | PTH03060Y/PTH05060Y | 330 ⁽³⁾ | | | μF |
| | | | PTH12060Y | 560 | | | |
| C_O1, C_O2 | External output capacitance | Capacitance value: Nonceramic | PTH03060Y/PTH05060Y | 470 ⁽⁴⁾ | 5500 ⁽⁵⁾ | | μF |
| | | PTH12060Y | | 940 ⁽⁴⁾ | 5500 ⁽⁵⁾ | | |
| | | Capacitance value: Ceramic | PTH03060Y/PTH05060Y | | 200 ⁽⁴⁾ | 300 | μF |
| | | PTH12060Y | | | 400 ⁽⁴⁾ | 600 | |
| Equiuvant series resistance (non-ceramic) | | | | 4 ⁽⁶⁾ | | | $\text{m}\Omega$ |
| MTBF | Reliability | Per Bellcore TR-332 50 % stress, $T_A = 40^\circ\text{C}$, ground benign | | 6 | | | 10^6 Hrs |

- (1) Rating is conditional on the module being directly soldered to a 4-layer PCB with 1 oz. copper. See the SOA curves or contact the factory for appropriate derating.
- (2) This control pin has an internal pull-up to the input voltage V_{IN} . If it is left open-circuit the module will operate when input power is applied. A small low-leakage (<100 nA) MOSFET is recommended for control. For further information, consult the related application note.
- (3) An input capacitor is required for proper operation. The capacitor must be rated for a minimum of 300 mA rms (750 mA rms for 12-V input) of ripple current.
- (4) The minimum value of external output capacitance value ensures that VTT meets the specified transient performance requirements for the memory bus terminations. Lower values of capacitance may be possible when the *measured* peak change in output current is consistently less than 3 A.
- (5) This is the calculated maximum. The minimum ESR limitation will often result in a lower value. Consult the capacitor application notes for further guidance.
- (6) This is the typical ESR for all the electrolytic (non-ceramic) output capacitance. Use 7 $\text{m}\Omega$ as the minimum when using max-ESR values to calculate.

Terminal Functions

| TERMINAL | DESCRIPTION | |
|----------------------|-------------|--|
| NAME | NO. | |
| V _{IN} | 2 | The positive input voltage power node to the module, which is referenced to common GND. |
| GND | 1, 7 | This is the common ground connection for the V _{IN} and V _{TT} power connections. It is also the 0-VDC reference for the control inputs. |
| V _{REF} | 8 | The module senses the voltage at this input to regulate the output voltage, V _{TT} . The voltage at V _{REF} is also the reference voltage for the system bus receiver comparators. It is normally set to precisely half the bus driver supply voltage (V _{DDQ} ÷ 2), using a resistor divider. The Thevenin impedance of the network driving the V _{REF} pin should not exceed 500 Ω . See the Typical DDR Application Diagram in the Application Information section for reference. |
| V _{TT} | 6 | This is the regulated power output from the module with respect to the GND node, and the tracking termination supply for the application data and address buses. It is precisely regulated to the voltage applied to the module's V _{REF} input, and is active active about 20 ms after a valid input source is applied to the module. Once active it will track the voltage applied at V _{REF} . |
| V _o Sense | 5 | The sense input allows the regulation circuit to compensate for voltage drop between the module and the load. For optimal voltage accuracy V _o Sense should be connected to V _{TT} . |
| Inhibit | 3 | The Inhibit pin is an open-collector/drain negative logic input that is referenced to GND. Applying a low-level ground signal to this input turns off the output voltage, V _{TT} . Although the module is inhibited, a voltage, V _{DDQ} will be present at the output terminals, fed through the DDR memory. When the Inhibit is active, the input current drawn by the regulator is significantly reduced. If the Inhibit pin is left open circuit, the module will produce an output whenever a valid input source is applied. See the Typical DDR Application Diagram in the Application Information section for reference. |
| N/C | 4, 9, 10 | No connect |



TYPICAL CHARACTERISTICS ($V_{REF} = 1.25$ V)⁽¹⁾⁽²⁾

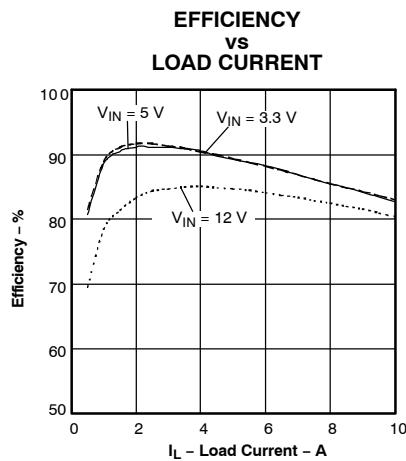


Figure 1.

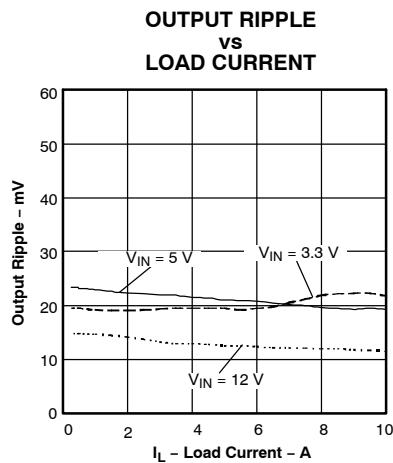


Figure 2.

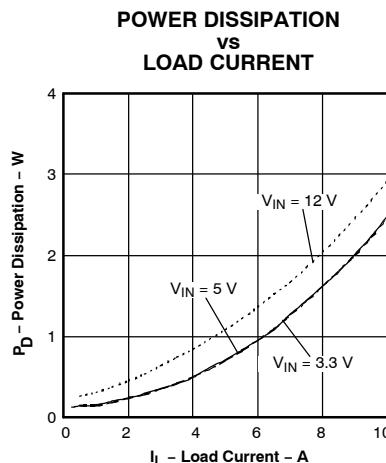


Figure 3.

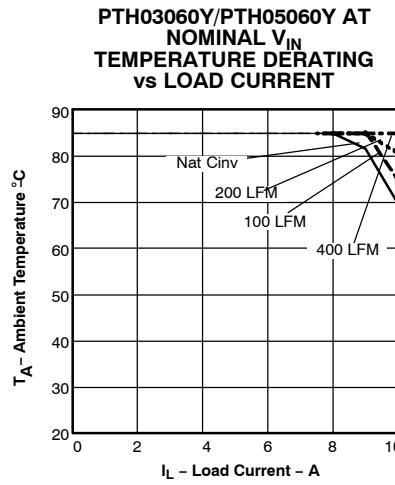


Figure 4.

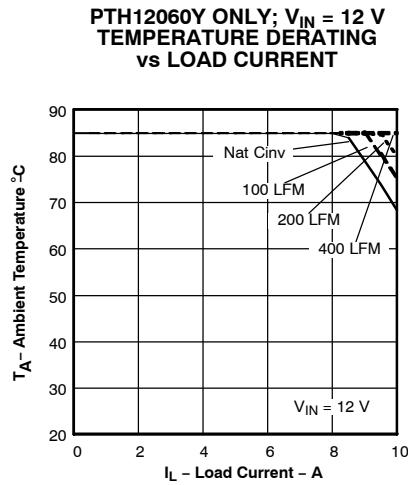


Figure 5.

- (1) The electrical characteristic data has been developed from actual products tested at 25°C. This data is considered typical for the converter. Applies to [Figure 1](#), [Figure 2](#), and [Figure 3](#).
- (2) The temperature derating curves represent the conditions at which internal components are at or below the manufacturer's maximum operating temperatures. Derating limits apply to modules soldered directly to a 4 in x 4 in double-sided PCB with 1 oz. copper. For surface mount packages (AS and AZ suffix), multiple vias (plated through holes) are required to add thermal paths around the power pins. Please refer to the mechanical specification for more information. Applies to [Figure 4](#), and [Figure 5](#).

TYPICAL CHARACTERISTICS

TRANSIENT PERFORMANCE FOR Δ 3-A LOAD CHANGE

PTH03060Y/PTH05060Y: SOURCE-SINK-SOURCE
TRANSIENT

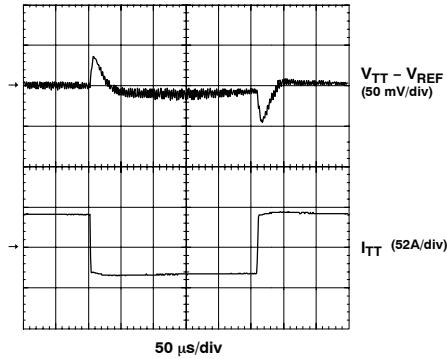


Figure 6.

PTH12060Y: SOURCE-SINK-SOURCE TRANSIENT

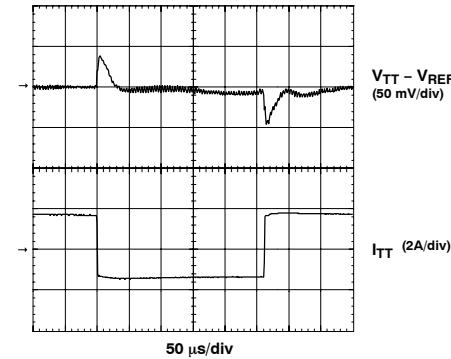
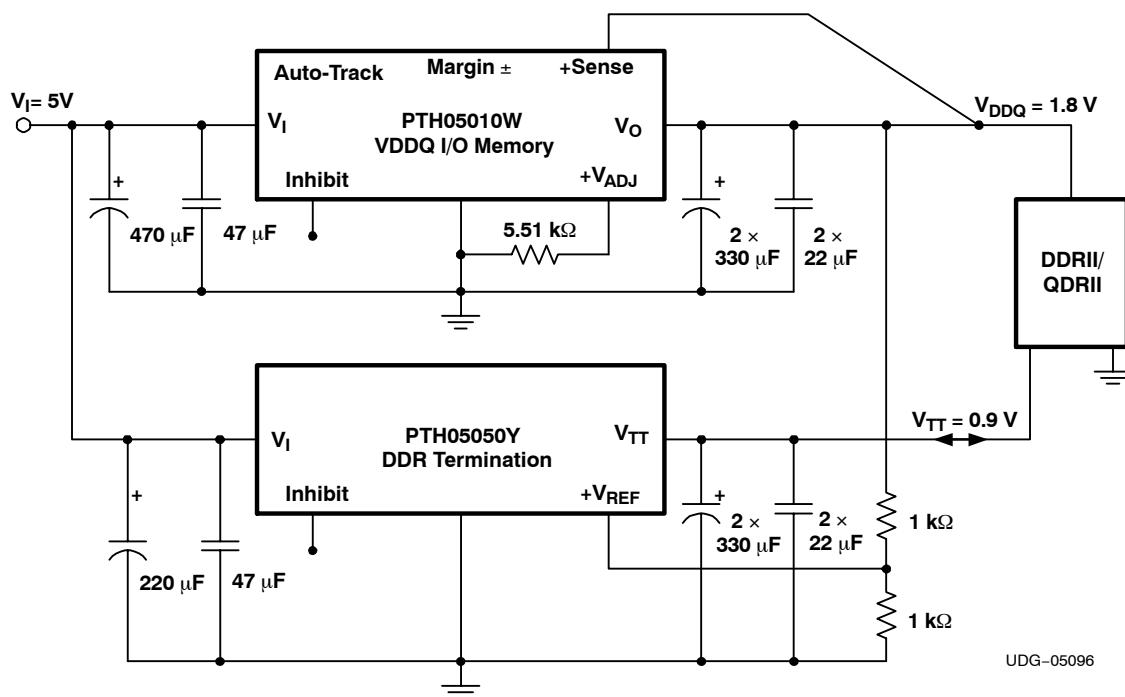


Figure 7.

APPLICATION INFORMATION

Typical DDR Application Diagram



CAPACITOR RECOMMENDATIONS FOR THE PTH03060Y AND PTH05060Y DDR POWER MODULES (3.3-V/5-V OPTION)

Input Capacitor

The recommended input capacitor(s) is determined by the $330 \mu\text{F}^{(1)}$ minimum capacitance and 300 mArms minimum ripple current rating.

Ripple current and less than 160 mΩ equivalent series resistance (ESR) values are the major considerations, along with temperature, when designing with different types of capacitors. Unlike polymer tantalum, regular tantalum capacitors have a recommended minimum voltage rating of $2 \times$ (maximum DC voltage + AC ripple). This is standard practice to insure reliability.

For improved ripple reduction on the input bus, ceramic capacitors may be substituted for electrolytic types using the minimum required capacitance.

Output Capacitors

For applications with load transients (sudden changes in load current), regulator response will benefit from external output capacitance. The recommended output capacitance of $470 \mu\text{F}$ will allow the module to meet its transient response specification (see Electrical Specifications table). For most applications, a high quality computer-grade aluminum electrolytic capacitor is adequate. These capacitors provide decoupling over the frequency range, 2 kHz to 150 kHz, and are suitable when ambient temperatures are above 0°C. For operation below 0°C tantalum, ceramic or Os-Con type capacitors are recommended. When using one or more non-ceramic capacitors, the calculated equivalent ESR should be no lower than 4 mΩ (7 mΩ using the manufacturer's maximum ESR for a single capacitor). A list of preferred low-ESR type capacitors are identified in Table 1.

APPLICATION INFORMATION (continued)

Ceramic Capacitors

Above 150 kHz the performance of aluminum electrolytic capacitors becomes less effective. To further improve the reflected input ripple current or the output transient response. Multilayer ceramic capacitors have very low ESR and their resonant frequency higher than the bandwidth of the regulator. They can be used to reduce the reflected ripple current at the input as well as improve the transient response of the output. When used on the output their combined ESR is not critical as long as the total value of ceramic capacitance does not exceed 300 μ F. Also, to prevent the formation of local resonances, do not place more than five identical ceramic capacitors in parallel with values of 10 μ F or greater.

Tantalum Capacitors

Tantalum type capacitors can be used at both the input and output, and are recommended for applications where the ambient operating temperature can be less than 0°C. The AVX TPS, Sprague 593D/594/595 and Kemet T495/T510 capacitor series are suggested over many other tantalum types due to their higher rated surge, power dissipation, and ripple current capability. As a caution many general purpose tantalum capacitors have considerably higher ESR, reduced power dissipation and lower ripple current capability. These capacitors are also less reliable when determining their power dissipation and surge current rating. Tantalum capacitors that do not have a stated ESR or surge current rating are not recommended for power applications.

When specifying Os-Con and polymer tantalum capacitors for the output, the minimum ESR limit will be encountered well before the maximum capacitance value is reached.

Capacitor Table

Table 1 identifies the characteristics of capacitors from a number of vendors with acceptable ESR and ripple current (rms) ratings. The recommended number of capacitors required at both the input and output buses is identified for each capacitor type.

This is not an extensive capacitor list. Capacitors from other vendors are available with comparable specifications. Those listed are for guidance. The RMS ripple current rating and ESR (at 100 kHz) are critical parameters necessary to insure both optimum regulator performance and long capacitor life.

Table 1. Input/Output Capacitors⁽¹⁾

| Capacitor Vendor, Type/Series (Style) | Capacitor Characteristics | | | | | Quantity | | Vendor Part Number |
|--|---------------------------|------------------|---------------------------------|--|--------------------|-----------|------------|--------------------|
| | Working Voltage (V) | Value (μ F) | Max ESR at 100 kHz (Ω) | Max Ripple Current at 85°C (Irms) (mA) | Physical Size (mm) | Input Bus | Output Bus | |
| Panasonic, Aluminum FC (Radial) FK (SMD) FC (SMD) | 10 | 470 | 0.117 | 555 | 8x11,5 | 1 | 1 | EEUFC1A471 |
| | 10 | 470 | 0.160 | 600 | 8x10,2 | 1 | 1 | EEVFK1A471P |
| | 10 | 470 | 0.150 | 670 | 10x10,2 | 1 | 1 | EEVFC1A471P |
| United Chemi-Con PXA, Poly-Aluminum (SMD) PS, Poly-Aluminum (Radial) LXZ, Aluminum (Radial) | 10 | 470 | 0.012 | 5300 | 10x12,2 | 1 | \leq 1 | PXA10VC471MJ12TP |
| | 10 | 470 | 0.012 | 5300 | 8x12,2 | 1 | \leq 1 | 10PS470MJ12 |
| | 10 | 470 | 0.120 | 555 | 8x12 | 1 | 1 | LXZ10VB471M8X12LL |
| Nichicon Aluminum WG (SMD) HD (Radial) PM (Radial) | 10 | 470 | 0.150 | 670 | 10x10 | 1 | 1 | UWG1A471MNR1GS |
| | 10 | 470 | 0.072 | 760 | 8x11,5 | 1 | 1 | UHD1A471MPR |
| | 16 | 330 | 0.120 | 625 | 10x12,5 | 1 | 2 | UPM1C331MPH6 |

(1) **Capacitor Supplier Verification**

Please verify availability of capacitors identified in this table. Capacitor suppliers may recommend alternative part numbers because of limited availability or obsolete products. In some instances, the capacitor product life cycle may be in decline and have short-term consideration for obsolescence.

RoHS, Lead-free and Material Details

Please consult capacitor suppliers regarding material composition, RoHS status, lead-free status, and manufacturing process requirements. Component designators or part number deviations can occur when material composition or soldering requirements are updated.

APPLICATION INFORMATION (continued)
Table 1. Input/Output Capacitors (continued)

| Capacitor Vendor, Type/Series (Style) | Capacitor Characteristics | | | | | Quantity | | Vendor Part Number |
|--|---------------------------|---------------------|---------------------------------------|--|--------------------------|------------------|--------------------|-----------------------|
| | Working Voltage (V) | Value (μ F) | Max ESR at 100 kHz (Ω) | Max Ripple Current at 85°C (Irms) (mA) | Physical Size (mm) | Input Bus | Output Bus | |
| Panasonic, Poly-Aluminum: S/SE (SMD) | 6.3 | 180 | 0.005 | 4000 | 7..3x4.3x4.2 | 2 | N/R ⁽²⁾ | EEFSE0J181R |
| Sanyo SEPC, Os-con (Radial) SVP (SMD) TPE, Poscap (SMD) | 16 | 470 | 0.010 | 6100 | 10x13 | 1 | \leq 1 | 16SEPC470M |
| | 6.3 | 470 | 0.015 | 4210 | 8x11.9 | 1 | \leq 2 | 6SVP470M |
| | 6.3 | 330 | 0.025 | 2400 | 7.3x4.3 | 1 | \leq 3 | 6TPE330ML |
| AVX, Tantalum TPS Series III TPS (SMD) | 10 | 470 | 0.045 | 1915 | 7.3Lx5.7W x4.1H | 1 | \leq 5 | TPSE477M010R0045 |
| | 10 | 470 | 0.100 | 1432 | | 1 | \leq 5 | TPSV477M010R0100 |
| | | | | | | | | |
| Kemet, Poly-Tantalum T520 (SMD) T530 (SMD) | 10 | 330 | 0.040 | 1800 | 4.3W x7.3L x4.0H | 1 | 1 | T520X337M010AS |
| | 10 | 330 | 0.010 | >5200 | | 1 | \leq 1 | T530X337M010ASE010 |
| | | | | | | | | |
| Vishay-Sprague 595D, Tantalum (SMD) 594D, Tantalum (SMD) 94SA, Poly-Aluminum (SMD) 94SVP, Poly-Aluminum (SMD) | 10 | 330 | 0.100 | 1040 | | 1 | \leq 5 | 595D377x0010D2T |
| | 10 | 330 | 0.045 | 2360 | | 1 | \leq 5 | 594D337X0016R2T |
| | 6.3 | 330 | 0.025 | 3500 | 7.2Lx6W x4.1H | 1 | \leq 3 | 94SA337X06R3FBP |
| | 6.3 | 470 | 0.017 | 3960 | 10 x10.5 8.3x12 | 1 | \leq 2 | 94SVP477X06R3E12 |
| | | | | | | | | |
| Kemet, Ceramic X5R (SMD) | 16 | 10 | 0.002 | – | 3225 mm | 1 | \leq 5 | C1210C106M4PAC |
| | 6.3 | 47 | 0.002 | | 3225 mm | 1 | \leq 5 | C1210C476K9PAC |
| Murata, Ceramic X5R (SMD) | 6.3 | 100 | 0.002 | – | 3225 mm | 1 ⁽³⁾ | \leq 3 | GRM32ER60J107M |
| | 6.3 | 47 | | | 3225 mm | 1 ⁽³⁾ | \leq 5 | GRM32ER60J476M |
| | 16 | 22 | | | | 1 ⁽³⁾ | \leq 5 | GRM32ER61C226K |
| | 16 | 10 | | | | 1 ⁽³⁾ | \leq 5 | GRM32DR61C106K |
| TDK, Ceramic X5R (SMD) | 6.3 | 100 | 0.002 | – | 3225 mm | 1 ⁽³⁾ | \leq 3 | C3225X5R0J107MT |
| | 6.3 | 47 | | | 3225 mm | 1 ⁽³⁾ | \leq 5 | C3225X5R0J476MT |
| | 16 | 22 | | | | 1 ⁽³⁾ | \leq 5 | C3225X5R1C226MT |
| | 16 | 10 | | | | 1 ⁽³⁾ | \leq 5 | C3225X5R1C106MT |

(2) N/R – Not recommended. The capacitor does not meet the minimum operating limits.

(3) A ceramic capacitor may be used to compliment electrolytic types at the input to further reduce high-frequency ripple current.

Designing for Very Fast Load Transients

The transient response of the DC/DC converter has been characterized using a load transient with a di/dt of 1 A/ μ s. The typical voltage deviation for this load transient is given in the data sheet specification table using the optional value of output capacitance. As the di/dt of a transient is increased, the response of a converter's regulation circuit ultimately depends on its output capacitor decoupling network. This is an inherent limitation with any DC/DC converter once the speed of the transient exceeds its bandwidth capability. If the target application specifies a higher di/dt or lower voltage deviation, the requirement can only be met with additional output capacitor decoupling. In these cases special attention must be paid to the type, value and ESR of the capacitors selected.

If the transient performance requirements exceed that specified in the data sheet, or the total amount of load capacitance is above 5500 μ F, the selection of output capacitors becomes more important.

CAPACITOR RECOMMENDATIONS FOR THE PTH12060Y DDR POWER MODULES (12-V OPTION)

Input Capacitor

The recommended input capacitance is determined by the 560 μF ^[1] minimum capacitance and 750 mArms minimum ripple current rating. A 10- μF X5R/X7R ceramic capacitor can be added to reduce the reflected input ripple current. The ceramic capacitor should be located between the input electrolytic and the module.

Ripple current, less than 100 m Ω equivalent series resistance (ESR) and temperature, are major considerations when selecting input capacitors. Unlike polymer-tantalum capacitors, regular tantalum capacitors have a recommended minimum voltage rating of $2 \times (\text{max. dc voltage} + \text{ac ripple})$. No tantalum capacitors were found with sufficient voltage rating to meet this requirement. At temperatures below 0°C, the ESR of aluminum electrolytic capacitors increases. For these applications, Os-Con, polymer-tantalum, and polymer-aluminum types should be considered.

Output Capacitors

For applications with load transients (sudden changes in load current), regulator response will benefit from external output capacitance. The recommended output capacitance of 940 μF will allow the module to meet its transient response specification (See Electrical Specifications table). For most applications, a high quality, computer-grade aluminum electrolytic capacitor is adequate. These capacitors provide decoupling over the frequency range, 2 kHz to 150 kHz, and are suitable for ambient temperatures above 0°C. Below 0°C, tantalum, ceramic, or Os-Con type capacitors are recommended. When using one or more nonceramic capacitors, the calculated equivalent ESR should be no lower than 4 m Ω (7 m Ω using the manufacturer's maximum ESR for a single capacitor).

A list of preferred low-ESR type capacitors are identified in [Table 2](#).

In addition to electrolytic capacitance, adding a 10- μF to 22- μF X5R/X7R ceramic capacitor to the output reduces the output ripple voltage and improves the regulator's transient response. The measurement of both the output ripple and transient response is also best achieved across a 10- μF ceramic capacitor.

Ceramic Capacitors

Above 150 kHz, the performance of aluminum electrolytic capacitors is less effective. Multilayer ceramic capacitors have a low ESR and a resonant frequency higher than the bandwidth of the regulator. They can be used to reduce the reflected ripple current at the input, and improve the transient response of the output. When used on the output, their combined ESR is not critical as long as the total value of ceramic capacitance does not exceed 600 μF . Also, to prevent the formation of local resonances, do not place more than five identical ceramic capacitors in parallel with values of 10 μF or greater.

Tantalum Capacitors

Tantalum type capacitors are most suited for use on the output bus, and are recommended for applications where the ambient operating temperature can be less than 0°C. The AVX TPS, Sprague 593D/594/595, and Kemet T495/T510 capacitor series are suggested over other tantalum types due to their higher rated surge, power dissipation, and ripple current capability. As a caution, many general-purpose tantalum capacitors have considerably higher ESR, reduced power dissipation, and lower ripple current capability. These capacitors are also less reliable as they have lower power dissipation and surge current ratings. Tantalum capacitors that do not have a stated ESR or surge current rating are not recommended for power applications.

When specifying Os-con and polymer tantalum capacitors for the output, the minimum ESR limit is encountered well before the maximum capacitance value is reached.

Capacitor Table

[Table 2](#) identifies the characteristics of capacitors from a number of vendors with acceptable ESR and ripple current (rms) ratings. The recommended number of capacitors required at both the input and output buses is identified for each capacitor type.

Note: This is not an extensive capacitor list. Capacitors from other vendors are available with comparable specifications. Those listed are for guidance. The RMS ripple current rating and ESR (at 100 kHz) are critical parameters necessary to insure both optimum regulator performance and long capacitor life.

Designing for Very Fast Load Transients

The transient response of the dc/dc converter is characterized using a load transient with a di/dt of 1 A/ μ s. The typical voltage deviation for this load transient is given in the data sheet specification table using the optional value of output capacitance. As the di/dt of a transient is increased, the response of a converter's regulation circuit ultimately depends on its output capacitor decoupling network. This is an inherent limitation with any dc/dc converter once the speed of the transient exceeds its bandwidth capability. If the target application specifies a higher di/dt or lower voltage deviation, the requirement is met with additional output capacitor decoupling. In these cases, special attention must be paid to the type, value, and ESR of the capacitors selected.

If the transient performance requirements exceed that specified in this data sheet, or the total amount of load capacitance is above 5500 μ F, the selection of output capacitors becomes more important.

Table 2. Input/Output Capacitors⁽¹⁾

| Capacitor Vendor, Type/Series (Style) | Capacitor Characteristics | | | | | Quantity | | Vendor Number |
|--|---------------------------|---------------------|---------------------------------------|---|--------------------------|--------------------|---------------|--------------------|
| | Working Voltage (V) | Value (μ F) | Max ESR at 100 kHz (Ω) | Max Ripple Current at 85°C (Irms) (mA) | Physical Size (mm) | Input Bus | Output Bus | |
| Panasonic, Aluminum FC (Radial) FK (SMD) | 25 | 560 | 0.065 | 1205 | 12,5 x 15 | 1 | 1 | EEUFC1E561S |
| | 25 | 1000 | 0.060 | 1100 | 12,5 x 13,5 | 1 | 1 | EEVFK1E102Q |
| | 35 | 680 | 0.060 | 1100 | 12,5 x 13,5 | 1 | 1 | EEVFK1V681Q |
| United Chemi-Con LXZ, Aluminum (Radial) PS, Poly-Aluminum (Radial) PXA, Poly-Aluminum (SMD) | 16 | 330 | 0.0014 | 5050 | 10 x 12,5 | 2 | \leq 2 | 16PS330MJ12 |
| | 16 | 680 | 0.068 | 1050 | 10 x 16 | 1 | 1 | LXZ16VB681M10X16LL |
| | 16 | 330 | 0.014 | 5050 | 10 x 12,2 | 2 | \leq 2 | PXA16VC331MJ12 |
| | 25 | 560 | 0.060 | 1060 | 12,5 x 15 | 1 | 1 | UPM1E561MHH6 |
| Nichicon Aluminum PM (Radial) HD (Radial) | 16 | 680 | 0.038 | 1430 | 10 x 16 | 1 | 1 | UHD1C681MHR |
| | 35 | 560 | 0.048 | 1360 | 16 x 15 | 1 | 1 | UPM1V561MHH6 |
| Sanyo TPE, pos-cap (SMD) SEPC, Os-con (Radial) SVP, Os-con (SMD) SVPC, Os-con (SMD) | 10 | 330 | 0.025 | 3000 | 7,3 L x 5,7 W | N/R ⁽²⁾ | \leq 3 | 10TPE330M |
| | 16 | 270 | 0.011 | 5000 | 8 x 12 | | \leq 1 | 16SP270M |
| | 16 | 330 | 0.016 | 4700 | 11 x 12 | 2 | \leq 2 | 16SVP330M |
| | 4 | 1200 | 0.010 | 4700 | 8 x 11,9 | N/R ⁽²⁾ | \leq 1 | 4SVPC1200M |
| | 10 | 470 | 0.045 | >1723 | 7,3 L x 5,7 W x4,1H | | \leq 5 | TPSE477M019R0045 |
| AVX, Tantalum TPS Series III (SMD) | 10 | 330 | 0.045 | >1723 | 7,3 L x 4,3 W x 4,3 H | N/R ⁽²⁾ | \leq 5 | TPSE337M019R0045 |
| TPS (SMD) | 10 | 470 | 0.045 | >1723 | 7,3 L x 4,3 W x 4,3 H | | \leq 5 | |
| Kemet T520, Poly-Tantalum (SMD) T530, Tantalum/Organic (SMD) | 10 | 470 | 0.040 | 1800 | 7,3 L x 4,3 W x 4,3 H | N/R ⁽²⁾ | \leq 5 | T520X477M006ASE040 |
| | 4 | 680 | 0.010 | >5100 | 7,3 L x 4,3 W x 4,3 H | | \leq 1 | T530X687M004ASE010 |
| | 6.3 | 470 | 0.010 | 5200 | 7,3 L x 4,3 W x 4,3 H | N/R ⁽²⁾ | \leq 1 | T530X477M006ASE010 |
| Vishay-Sprague 594D, Tantalum (SMD) 94SA, organic (Radial) 94SVP, Organic (SMD) | 10 | 470 | 0.100 | 1440 | 7,2 L x 6 W x 4,1 H | N/R ⁽²⁾ | \leq 5 | 595D477X0010R2T |
| | 16 | 1000 | 0.015 | >9700 | 16 x 25 | | 1 | \leq 2 |
| | 16 | 330 | 0.017 | >4500 | 10 x 12,7 | 2 | \leq 2 | 94Sa108X0016HBP |

(1) Capacitor Supplier Verification

Please verify availability of capacitors identified in this table. Capacitor suppliers may recommend alternative part numbers because of limited availability or obsolete products. In some instances, the capacitor product life cycle may be in decline and have short-term consideration for obsolescence.

RoHS, Lead-free and Material Details

Please consult capacitor suppliers regarding material composition, RoHS status, lead-free status, and manufacturing process requirements. Component designators or part number deviations can occur when material composition or soldering requirements are updated.

(2) N/R – Not recommended. The capacitor voltage rating does not meet the minimum operating limits.

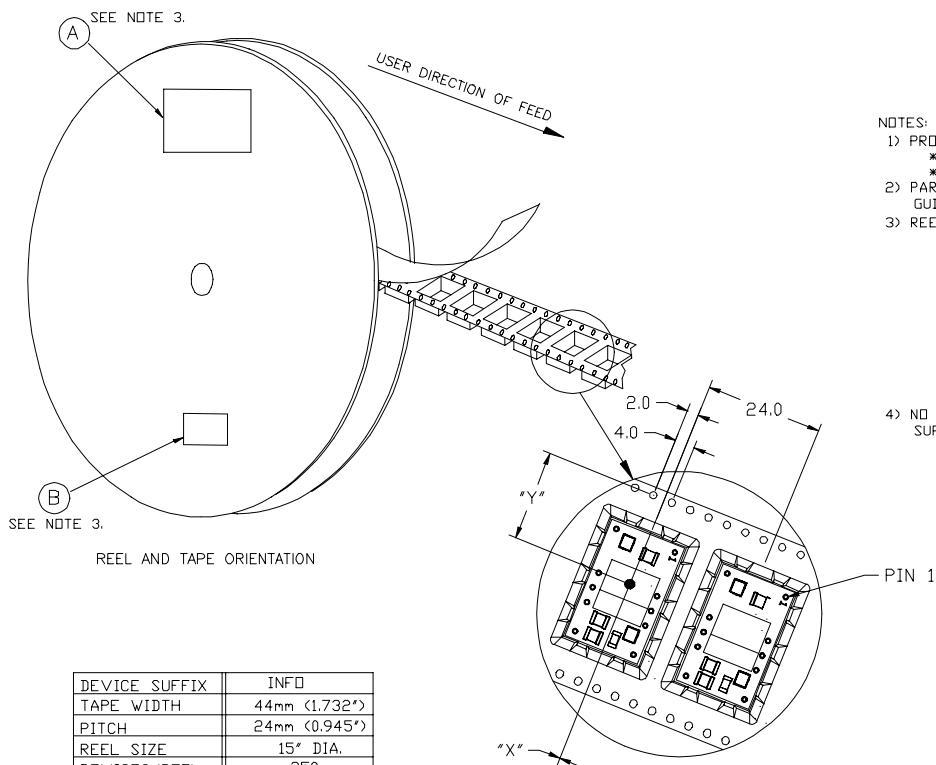
(3) A total capacitance of 540 μ F is acceptable based on the combined ripple current rating.

Table 2. Input/Output Capacitors (continued)

| Capacitor Vendor, Type/Series (Style) | Capacitor Characteristics | | | | | Quantity | | Vendor Number |
|--|---------------------------|---------------------|---------------------------------------|---|-----------------------|--------------------|---------------|-----------------|
| | Working Voltage (V) | Value (μ F) | Max ESR at 100 kHz (Ω) | Max Ripple Current at 85°C (Irms) (mA) | Physical Size (mm) | Input Bus | Output Bus | |
| Kemet, Ceramic X5R (SMD) | 16 | 10 | 0.002 | | 3225 mm | 1 ⁽⁴⁾ | \leq 5 | C1210C106M4PAC |
| | 6.3 | 47 | 0.002 | | 3225 mm | N/R ⁽²⁾ | \leq 5 | C1210C476K9PAC |
| Murata, Ceramic X5R (SMD) | 6.3 | 100 | 0.002 | | 3225 mm | N/R ⁽²⁾ | \leq 4 | GRM32ER60J107M |
| | 6.3 | 47 | | | 3225 mm | N/R ⁽²⁾ | \leq 5 | GRM32ER60J476M |
| | 16 | 22 | | | | 1 ⁽⁴⁾ | \leq 5 | GRM32ER61C226K |
| | 16 | 10 | | | | 1 ⁽⁴⁾ | \leq 5 | GRM32DR61C106K |
| TDK, Ceramic X5R (SMD) | 6.3 | 100 | 0.002 | | 3225 mm | N/R ⁽²⁾ | \leq 4 | C3225X5R0J107MT |
| | 6.3 | 47 | | | 3225 mm | N/R ⁽²⁾ | \leq 5 | C3225X5R0J476MT |
| | 16 | 22 | | | | 1 ⁽⁴⁾ | \leq 5 | C3225X5R1C226MT |
| | 16 | 10 | | | | 1 ⁽⁴⁾ | \leq 5 | C3225X5R1C106MT |

(4) Ceramic capacitors are recommended to complement electrolytic types at the input bus by reducing high-frequency ripple current.

TAPE AND REEL SPECIFICATION



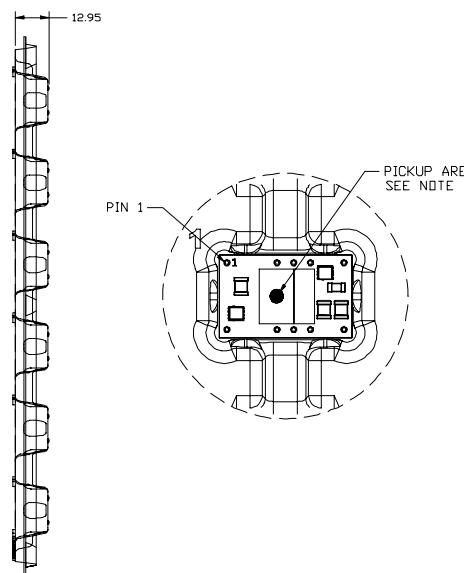
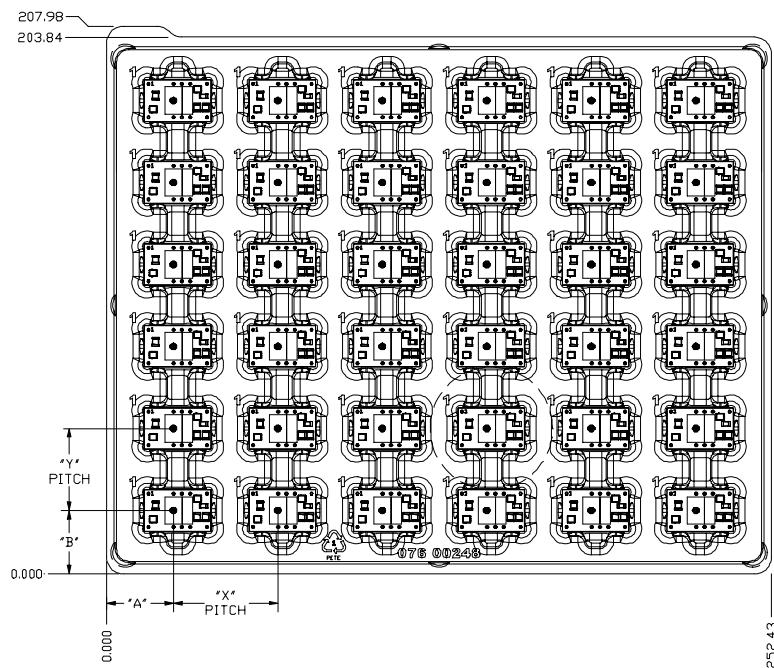
NOTES:

- 1) PROCESS IN ACCORDANCE WITH EIA-481-2
 - * TAPE LEADER DIMENSION 15.30" MIN.
 - * TAPE TRAILER DIMENSION 6.30" MIN.
- 2) PARTS SHOULD BE PACKAGED IN ACCORDANCE WITH ESD GUIDELINES IN EIA-541.
- 3) REEL LABEL: *A*- * TI PART NUMBER
 - * QUANTITY
 - * DATE CODE
 - * LOT NUMBER
 - * MSL DATA
 - * MADE IN
 - * ASSY SITE ORIGIN
 - * COUNTRY OF ORIGIN
 - * SUPPLIER
- 4) NO REQUIREMENT FOR TAPE DIRECTION OF FEED FROM SUPPLIER REEL.

B- ANTI-STATIC CAUTION LABEL

| PTXXXX6X | *X* | *Y* |
|----------------|-------|--------|
| PTH03060/05060 | 0.0mm | 18.4mm |
| PTH12060 | 0.0mm | 17.9mm |
| PTN78060 | 1.2mm | 21.8mm |

TRAY SPECIFICATION



NOTE: THE INDUCTOR IS USED TO PICK AND PLACE THE MODULE. IT'S LOCATION MAY VARY FROM PACKAGE STYLE. SEE PRODUCT TABLE

| PTXXXX6X | "A" | "B" | "X" | "Y" |
|----------------|-------|-------|-------|-------|
| PTH03060/05060 | 25.46 | 24.13 | | |
| PTH12060 | 24.66 | 24.13 | 39.52 | 31.12 |
| PTN78060 | 28.61 | 25.35 | | |

DEVICES/TRAY 36

ALL DIMENSIONS ARE IN MILLIMETER.

PACKAGING INFORMATION

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|-----------------------|---------------|----------------------|---------------------------------|-----------------------|-------------|--------------------------------------|--|--------------|---------------------|
| PTH03060YAH | Last Time Buy | Production | Through-Hole Module (EUW) 10 | 36 TIW TRAY | Exempt | SN | N/A for Pkg Type | -40 to 85 | |
| PTH03060YAH.B | NRND | Production | Through-Hole Module (EUW) 10 | 36 TIW TRAY | Exempt | SN | N/A for Pkg Type | -40 to 85 | |
| PTH03060YAST | Last Time Buy | Production | Surface Mount Module (EUY) 10 | 250 SMALL T&R | No | SNPB | Level-1-235C-UNLIM/ Level-3-260C-168HRS | -40 to 85 | |
| PTH03060YAZT | Last Time Buy | Production | Surface Mount Module (EUY) 10 | 250 SMALL T&R | Exempt | SNAGCU | Level-3-260C-168 HR | -40 to 85 | |
| PTH03060YAZT.B | NRND | Production | Surface Mount Module (EUY) 10 | 250 SMALL T&R | Exempt | SNAGCU | Level-3-260C-168 HR | -40 to 85 | |
| PTH05060YAH | Last Time Buy | Production | Through-Hole Module (EUW) 10 | 36 TIW TRAY | Exempt | SN | N/A for Pkg Type | -40 to 85 | |
| PTH05060YAH.B | NRND | Production | Through-Hole Module (EUW) 10 | 36 TIW TRAY | Exempt | SN | N/A for Pkg Type | -40 to 85 | |
| PTH12060YAH | Active | Production | Through-Hole Module (EUW) 10 | 36 TIW TRAY | Exempt | SN | N/A for Pkg Type | -40 to 85 | |
| PTH12060YAH.B | Active | Production | Through-Hole Module (EUW) 10 | 36 TIW TRAY | Exempt | SN | N/A for Pkg Type | -40 to 85 | |
| PTH12060YAST | Active | Production | Surface Mount Module (EUY) 10 | 250 SMALL T&R | No | SNPB | Level-1-235C-UNLIM/ Level-3-260C-168HRS | -40 to 85 | |
| PTH12060YAST.B | Active | Production | Surface Mount Module (EUY) 10 | 250 SMALL T&R | No | SNPB | Level-1-235C-UNLIM/ Level-3-260C-168HRS | -40 to 85 | |
| PTH12060YAZ | Active | Production | Surface Mount Module (EUY) 10 | 36 TIW TRAY | Exempt | SNAGCU | Level-3-260C-168 HR | -40 to 85 | |
| PTH12060YAZ.B | Active | Production | Surface Mount Module (EUY) 10 | 36 TIW TRAY | Exempt | SNAGCU | Level-3-260C-168 HR | -40 to 85 | |
| PTH12060YAZT | Active | Production | Surface Mount Module (EUY) 10 | 250 SMALL T&R | Exempt | SNAGCU | Level-3-260C-168 HR | -40 to 85 | |
| PTH12060YAZT.B | Active | Production | Surface Mount Module (EUY) 10 | 250 SMALL T&R | Exempt | SNAGCU | Level-3-260C-168 HR | -40 to 85 | |

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

(2) Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) RoHS values: Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

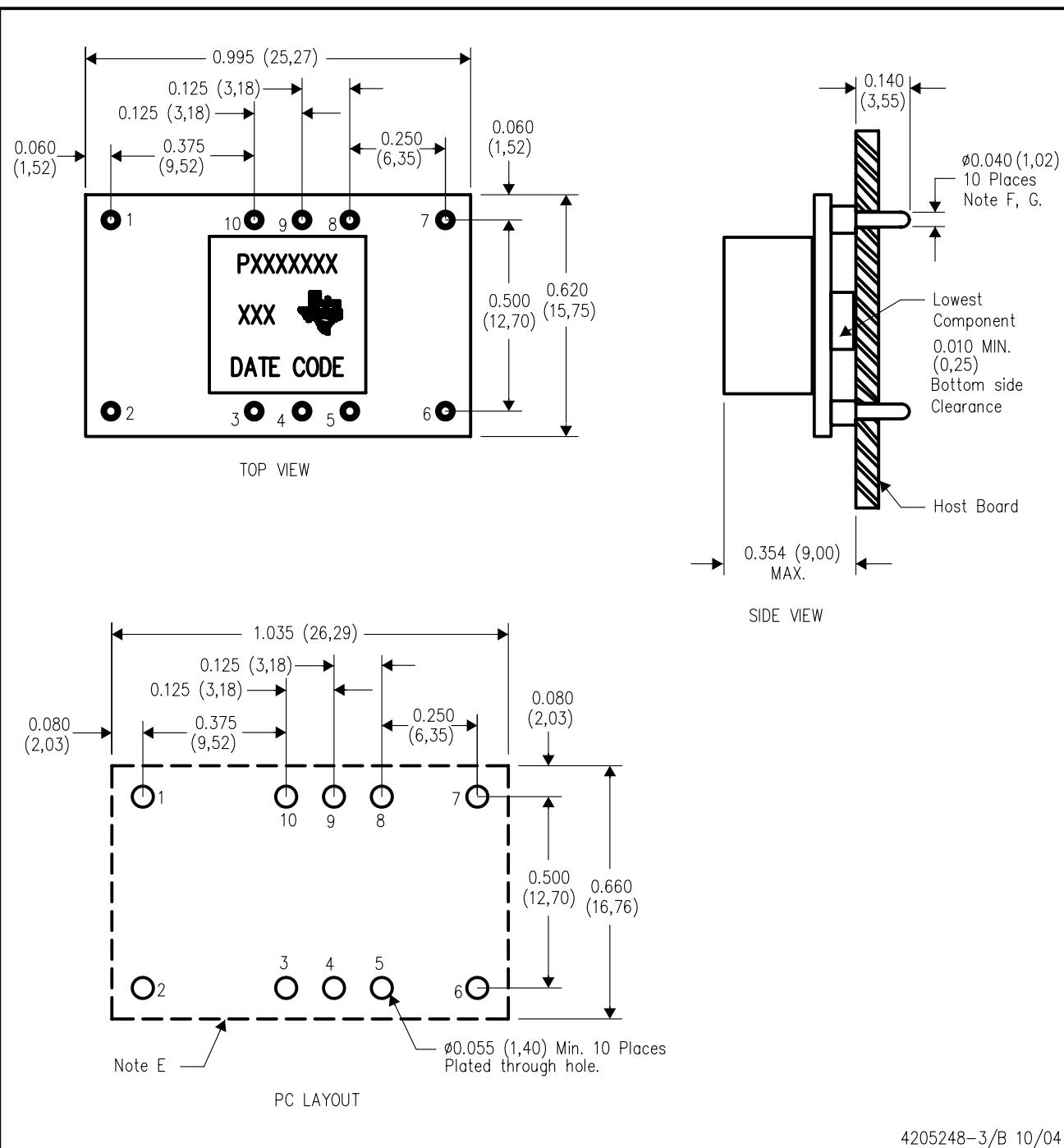
Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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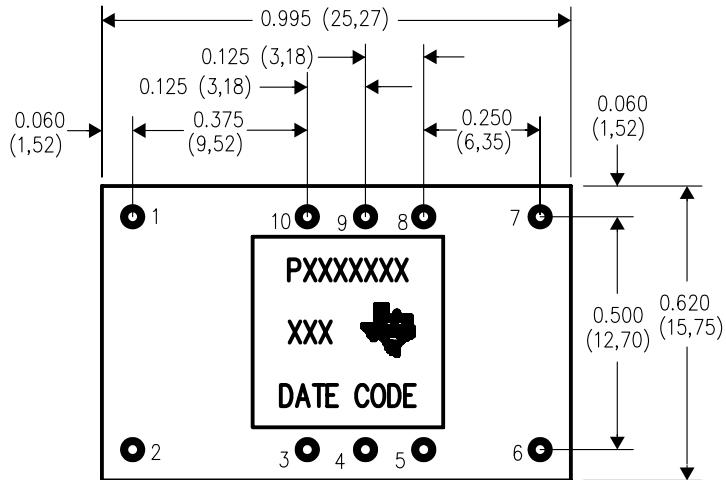
EUW (R-PDSS-T10)

DOUBLE SIDED MODULE

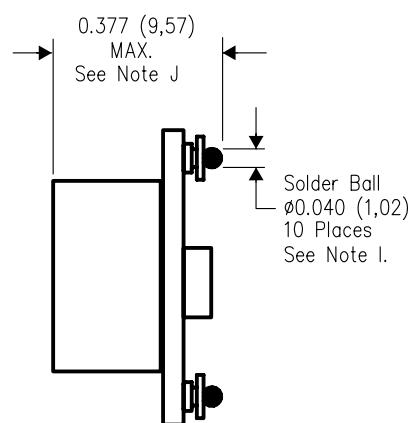


EUY (R-PDSS-B10)

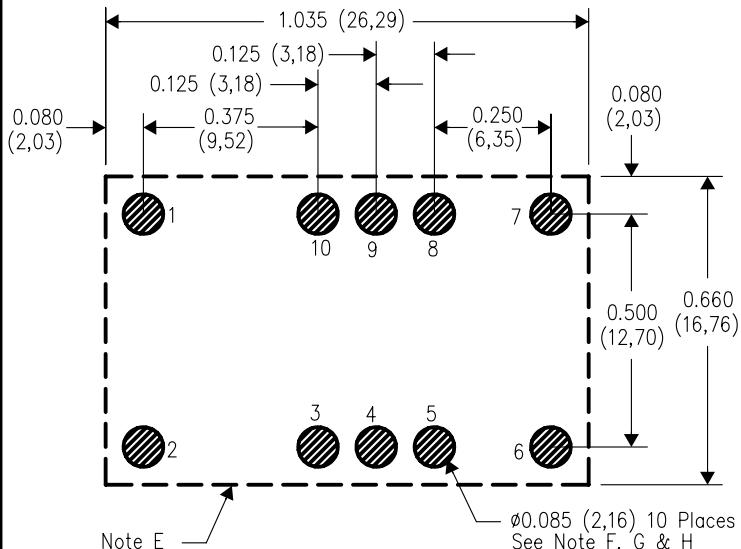
DOUBLE SIDED MODULE



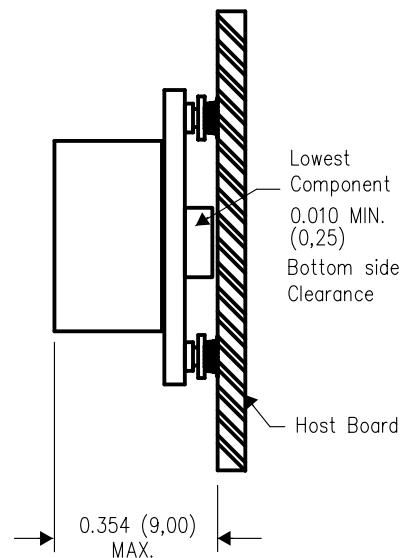
TOP VIEW



SIDE VIEW



PC LAYOUT



4205249-3/B 10/04

NOTES:

- A. All linear dimensions are in inches (mm).
- B. This drawing is subject to change without notice.
- C. 2 place decimals are ± 0.030 (± 0.76 mm).
- D. 3 place decimals are ± 0.010 (± 0.25 mm).
- E. Recommended keep out area for user components.
- F. Power pin connection should utilize two or more vias to the interior power plane of 0.025 (0,63) I.D. per input, ground and output pin (or the electrical equivalent).
- G. Paste screen opening: 0.080 (2,03) to 0.085 (2,16).
Paste screen thickness: 0.006 (0,15).
- H. Pad type: Solder mask defined.
- I. All pins: Material – Copper Alloy
Finish – Tin (100%) over Nickel plate
Solder Ball – See product data sheet.
- J. Dimension prior to reflow solder.

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